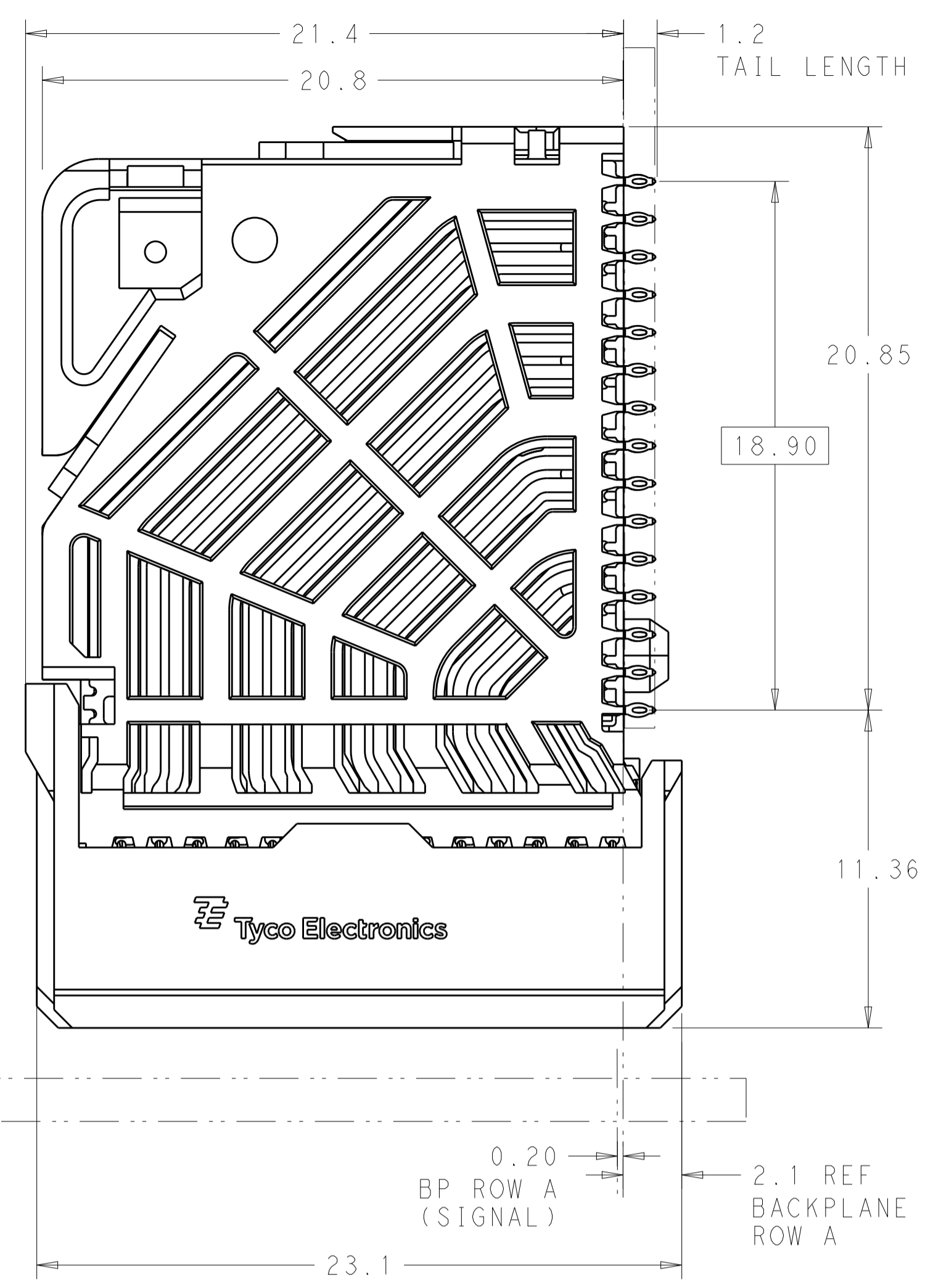
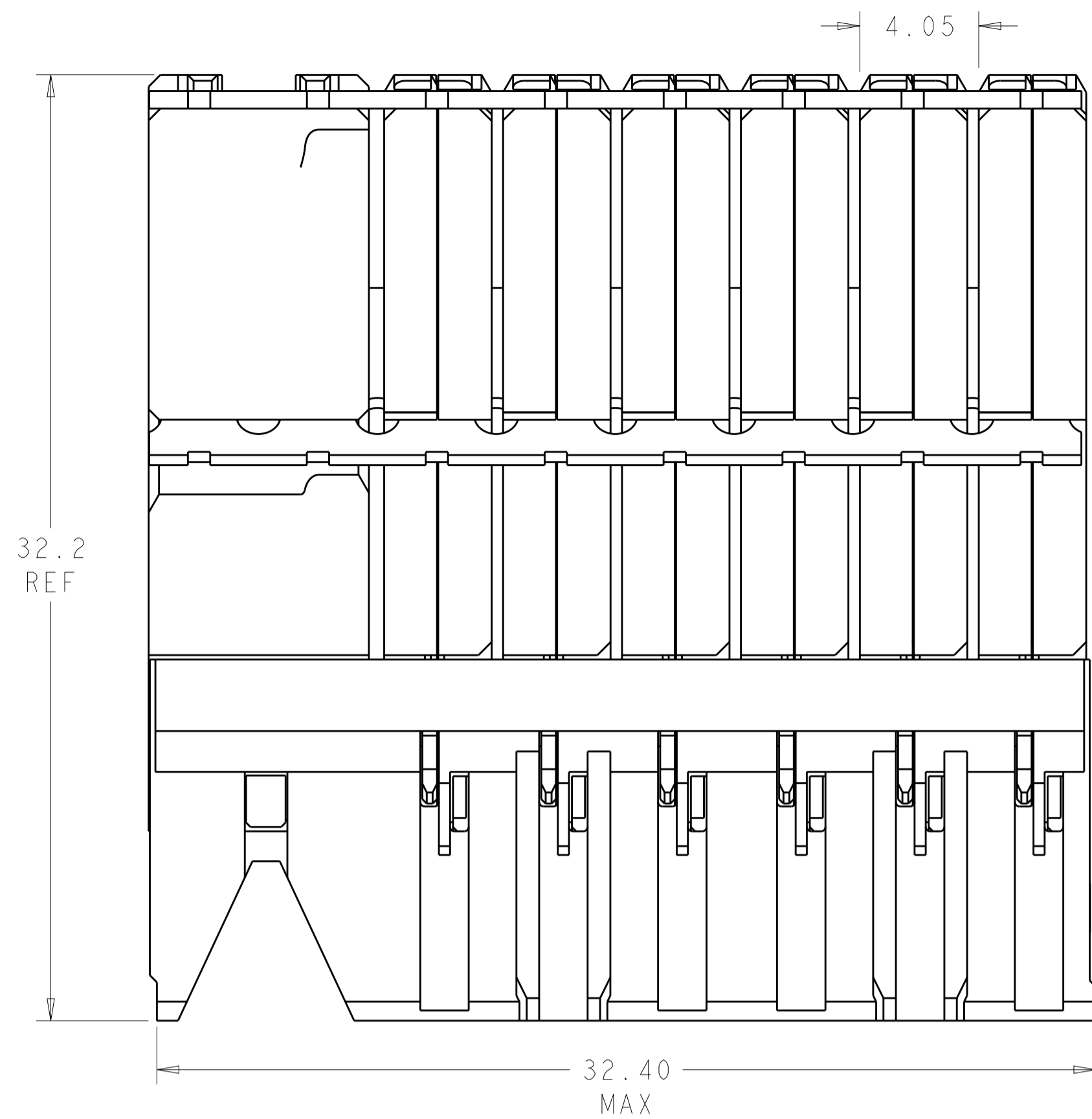
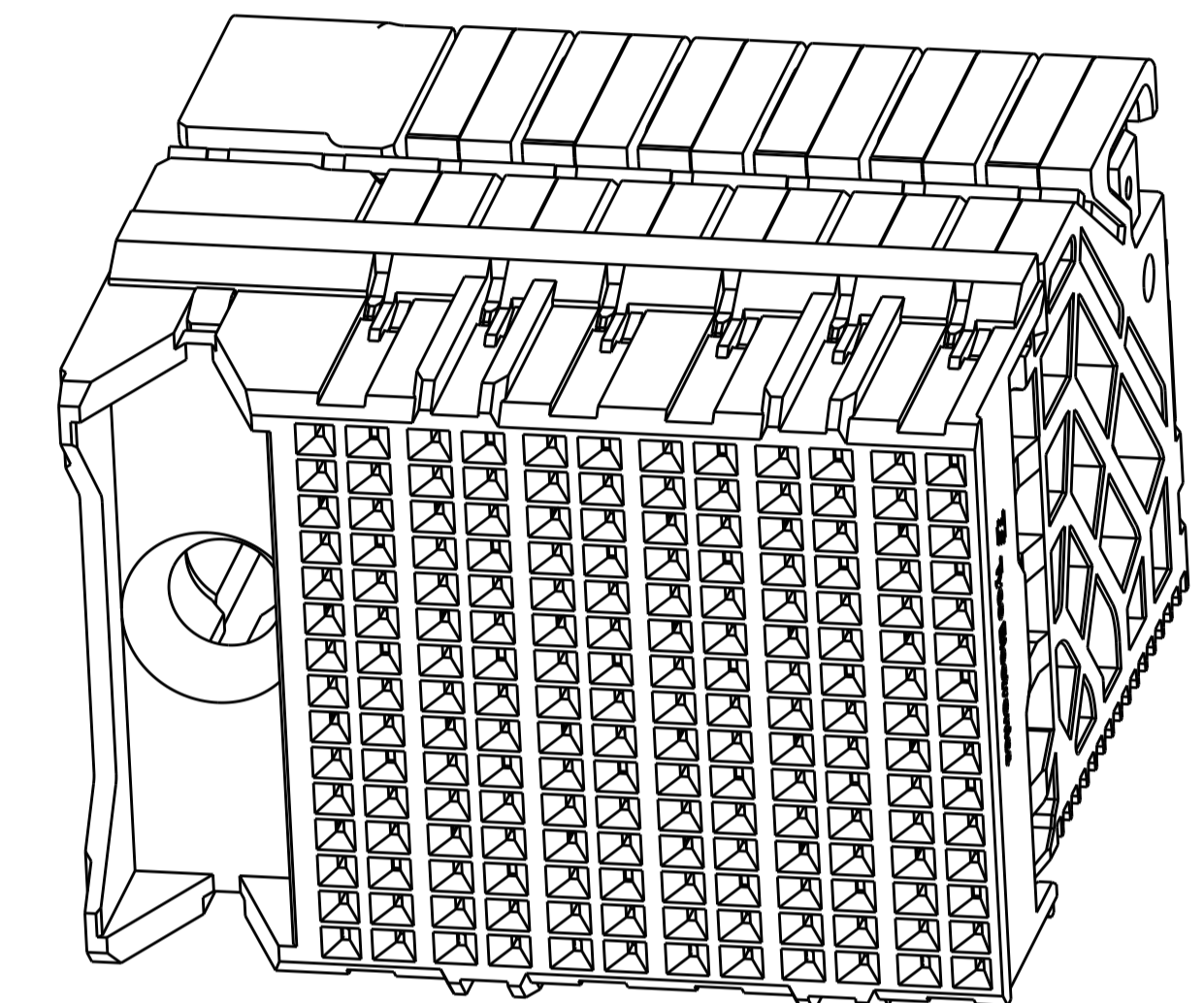


LOC	DIST	REV	DATE	BY	APPV
AD	00	B2	10APR2015	AP	DD

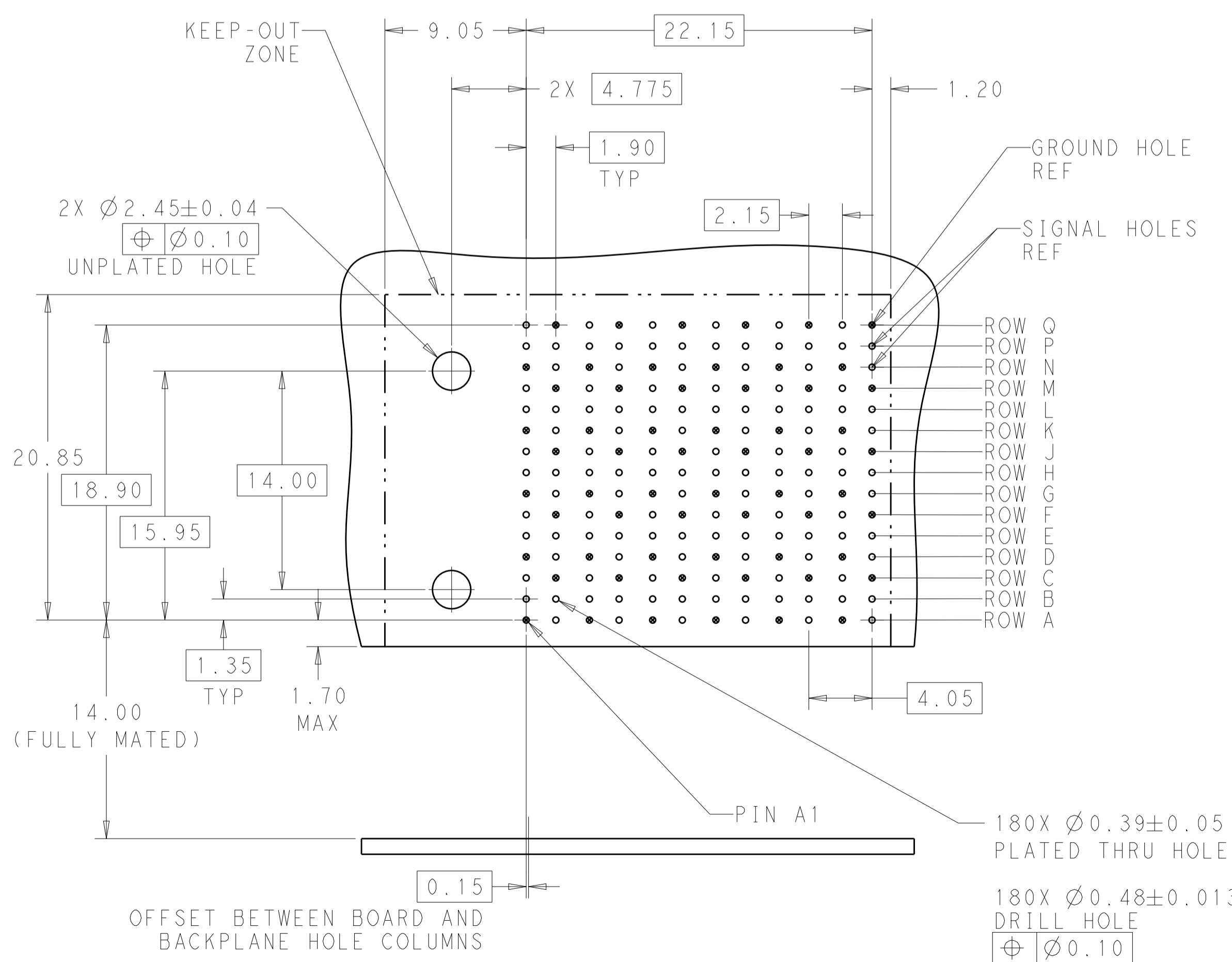
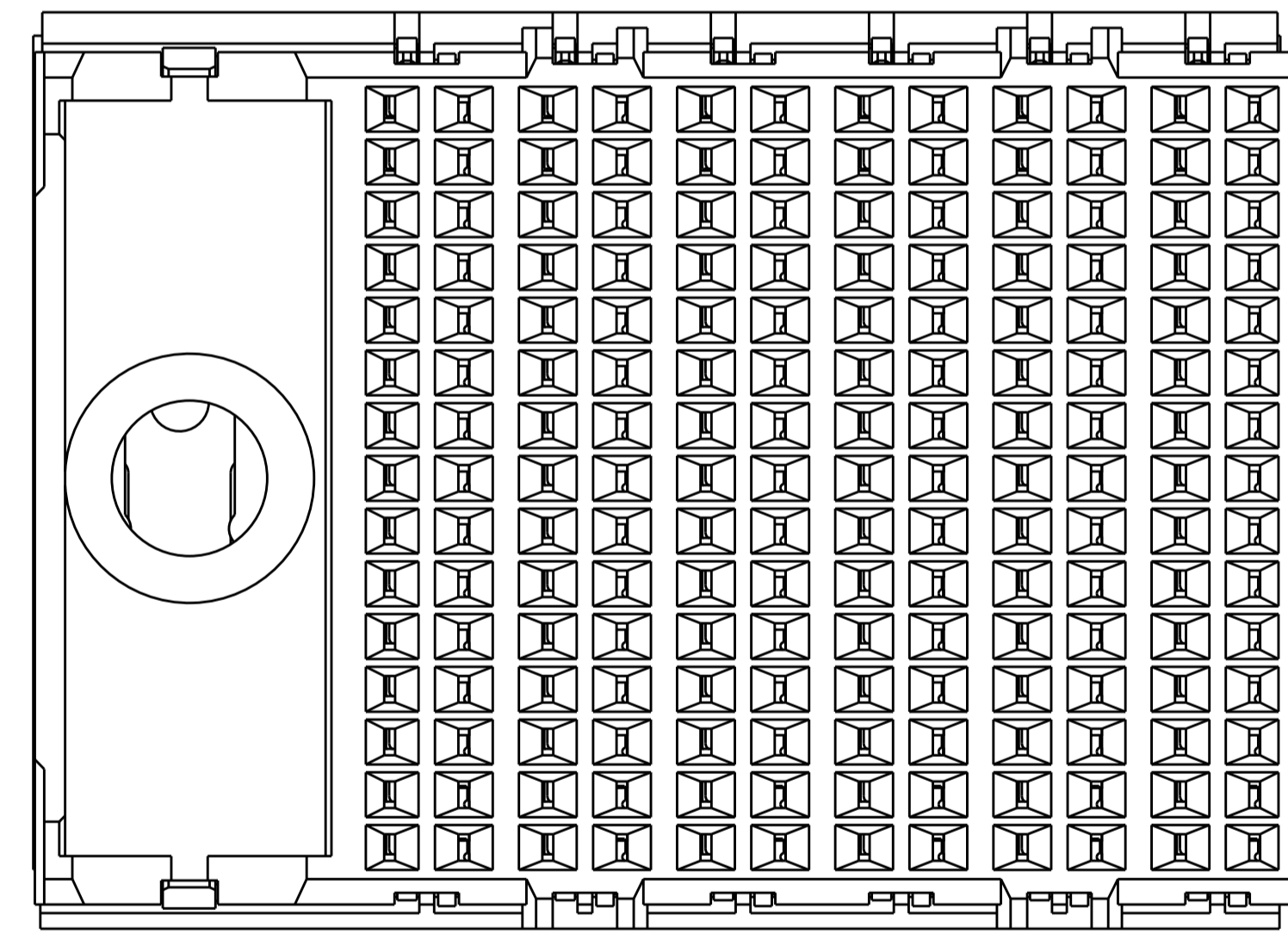


- ⚠ MATERIAL:
HOUSING: LCP, GLASS FILLED, UL94V-0.
TERMINALS: HIGH PERFORMANCE COPPER ALLOY.
- ⚠ FINISH:
30μ" SELECTIVE GOLD IN CONTACT AREA. SELECTIVE TIN ON PCB TAILS, NICKEL OVERALL.
- 3. CONNECTORS SUPPLIED WITH MOUNTING SCREWS.



SCALE 4:1

REFER TO WWW.TE.COM FOR PRODUCT AVAILABILITY



OFFSET BETWEEN BOARD AND BACKPLANE HOLE COLUMNS

RECOMMENDED PCB LAYOUT
MIN BOARD THICKNESS 1.0

NONE	⚠	2132696-1
KEY POSITION	FINISH	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWN: 29APR2011	TE Connectivity
DIMENSIONS: mm		CHK: D. DIXON 29APR2011	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: D. DIXON 29APR2011	NAME: IMPACT, ORTHOGONAL, 5 PAIR, DAUGHTERCARD, 12 COLUMN, LEFT GUIDED, SIGNAL MODULE, 0.39 EYELET
0 PLC ± 1 PLC ±0.25 2 PLC ±0.15 3 PLC ± 4 PLC ± ANGLES ±		PRODUCT SPEC	
MATERIAL		WEIGHT	SIZE: A100779C=2132696
FINISH: SEE TABLE		Customer Drawing	RESTRICTED TO: -
		SCALE: 6:1	SHEET 1 OF 1 REV: B2